

# μA747 Dual Operational Amplifier

Linear Division Operational Amplifiers

## Description

The μA747 contains a pair of high performance monolithic operational amplifiers constructed using the Fairchild Planar Epitaxial process. They are intended for a wide range of analog applications where board space or weight are important. High common mode voltage range and absence of latch up make the μA747 ideal for use as a voltage follower. The high gain and wide range of operating voltage provide superior performance in integrator, summing amplifier, and general feedback applications. The μA747 is short circuit protected and requires no external components for frequency compensation. The internal 6 dB/octave roll-off insures stability in closed loop applications. For single amplifier performance, see μA741 data sheet.

- No Frequency Compensation Required
- Short Circuit Protection
- Offset Voltage Null Capability
- Large Common Mode And Differential Voltage Ranges
- Low Power Consumption
- No Latch Up

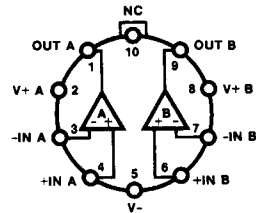
## Absolute Maximum Ratings

Storage Temperature Range	
Metal Can and Ceramic DIP	-65°C to +175°C
Molded DIP and SO-14	-65°C to +150°C
Operating Temperature Range	
Extended (μA747AM, μA747M)	-55°C to +125°C
Commercial (μA747EC, μA747C)	0°C to +70°C
Lead Temperature	
Metal Can and Ceramic DIP (soldering, 60 s)	300°C
Molded DIP and SO-14 (soldering, 10 s)	265°C
Internal Power Dissipation <sup>1, 2</sup>	
10L-Metal Can	1.07 W
14L-Ceramic DIP	1.36 W
14L-Molded DIP	1.04 W
SO-14	0.93 W
Supply Voltage	
μA747A, μA747	± 22 V
μA747E, μA747C	± 18 V
Differential Input Voltage	± 30 V
Input Voltage <sup>3</sup>	± 15 V
Voltage Between Offset Null and V-	± 0.5 V
Output Short Circuit Duration <sup>4</sup>	Indefinite

## Notes

1.  $T_{J \text{ Max}} = 150^\circ\text{C}$  for the Molded DIP and SO-14, and  $175^\circ\text{C}$  for the Metal Can Ceramic DIP.
2. Ratings apply to ambient temperature at  $25^\circ\text{C}$ . Above this temperature, derate the 10L-Metal Can at  $7.1 \text{ mW}/^\circ\text{C}$ , the 14L-Ceramic DIP at  $9.1 \text{ mW}/^\circ\text{C}$ , the 14L-Molded DIP at  $8.3 \text{ mW}/^\circ\text{C}$ , and the SO-14 at  $7.5 \text{ mW}/^\circ\text{C}$ .
3. For supply voltages less than  $\pm 15 \text{ V}$ , the absolute maximum input voltage is equal to the supply voltage.

## Connection Diagram 10-Lead Metal Package (Top View)



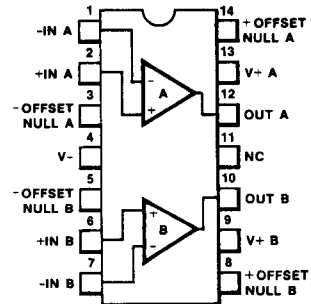
CD00771F

Lead 5 connected to case.

## Order Information

Device Code	Package Code	Package Description
μA747HM	5X	Metal
μA747HC	5X	Metal
μA747AHM	5X	Metal
μA747EHC	5X	Metal

## Connection Diagram 14-Lead DIP and SO-14 Package (Top View)



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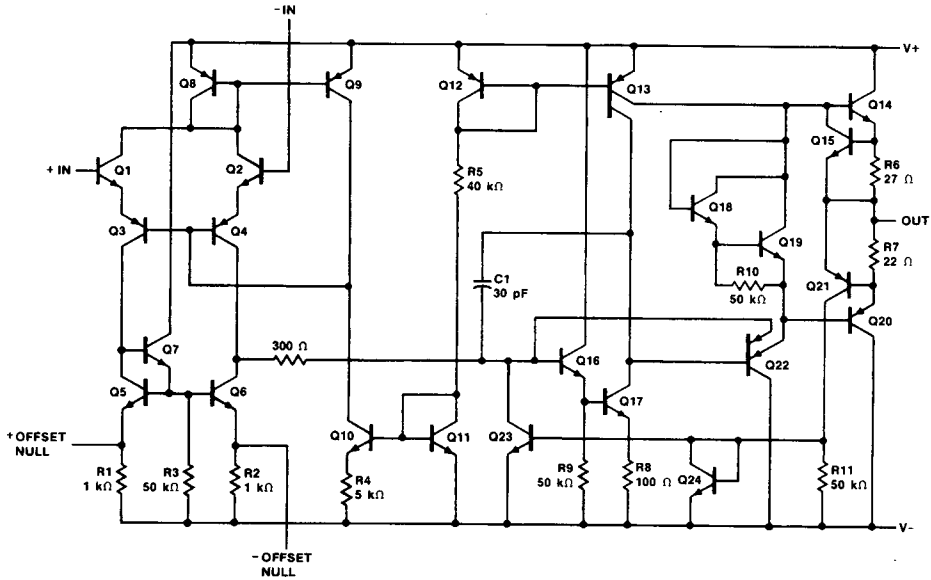
## Order Information

Device Code	Package Code	Package Description
μA747DM	6A	Ceramic DIP
μA747DC	6A	Ceramic DIP
μA747PC	9A	Molded DIP
μA747SC	KD	Molded Surface Mount
μA747ADM	6A	Ceramic DIP
μA747EDC	6A	Ceramic DIP

4. Short circuit may be to ground or either supply. Rating applies to  $125^\circ\text{C}$  case temperature or  $75^\circ\text{C}$  ambient temperature.

# $\mu A747$

## Equivalent Circuit (1/2 of circuit)



8D00351F

V+A is internally connected to V+B.

# μA747

## μA747 and μA747C

Electrical Characteristics  $T_A = 25^\circ\text{C}$ ,  $V_{CC} = \pm 15\text{ V}$ , unless otherwise specified.

Symbol	Characteristic	Condition	μA747			μA747C			Unit
			Min	Typ	Max	Min	Typ	Max	
$V_{IO}$	Input Offset Voltage	$R_S \leq 10\text{ k}\Omega$		1.0	5.0		1.0	6.0	mV
$V_{IO\text{ adj}}$	Input Offset Voltage Adjustment Range			$\pm 15$			$\pm 15$		mV
$I_{IO}$	Input Offset Current			20	200		20	200	nA
$I_{IB}$	Input Bias Current			80	500		80	500	nA
$Z_I$	Input Impedance		0.3	2.0		0.3	2.0		MΩ
$I_{CC}$	Supply Current			3.4	5.6		3.9	5.6	mA
$P_c$	Power Consumption			100	170		100	170	mW
PSRR	Power Supply Rejection Ratio			30	150				$\mu\text{V}/\text{V}$
		$V_{CC} = \pm 5.0\text{ V to } \pm 18\text{ V}$					30	150	
$I_{OS}$	Output Short Circuit Current			25			25		mA
$A_{VS}$	Large Signal Voltage Gain	$R_L \geq 2.0\text{ k}\Omega$ , $V_O = \pm 10\text{ V}$	50	200		25	200		V/mV
TR	Transient Response	Rise time	$V_I = 50\text{ mV}$ , $R_L = 2.0\text{ k}\Omega$ , $C_L = 100\text{ pF}$ , $A_V = 1.0$			0.3		0.3	$\mu\text{s}$
		Overshoot		5.0		5.0			%
BW	Bandwidth			1.0			1.0		MHz
SR	Slew Rate	$R_L = 2.0\text{ k}\Omega$ , $A_V = 1.0$		0.5			0.5		V/ $\mu\text{s}$
CS	Channel Separation			120			120		dB

The following specifications apply over the range of  $-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$  for μA747,  $0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$  for μA747C

$V_{IO}$	Input Offset Voltage	$R_S \leq 10\text{ k}\Omega$		1.0	6.0		1.0	7.5	mV
$I_{IO}$	Input Offset Current	$0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$					7.0	300	nA
		$T_A = +125^\circ\text{C}$		7.0	200				
		$T_A = -55^\circ\text{C}$		85	500				
$I_{IB}$	Input Bias Current	$0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$					30	800	nA
		$T_A = +125^\circ\text{C}$		0.03	0.5				$\mu\text{A}$
		$T_A = -55^\circ\text{C}$		0.3	1.5				
$I_{CC}$	Supply Current	$0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$					4.0	6.6	mA
		$T_A = +125^\circ\text{C}$		3.0	5.0				
		$T_A = -55^\circ\text{C}$		4.0	6.6				
$P_c$	Power Consumption	$0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$					120	200	mW
		$T_A = +125^\circ\text{C}$		90	150				
		$T_A = -55^\circ\text{C}$		120	200				
CMR	Common Mode Rejection	$R_S \leq 10\text{ k}\Omega$	70	90		70	90		dB
$V_{IR}$	Input Voltage Range		$\pm 12$	$\pm 13$		$\pm 12$	$\pm 13$		V
PSRR	Power Supply Rejection Ratio			30	150				$\mu\text{V}/\text{V}$
		$V_{CC} = \pm 5.0\text{ V to } \pm 18\text{ V}$					30	150	
$A_{VS}$	Large Signal Voltage Gain	$R_L \geq 2.0\text{ k}\Omega$ , $V_O = \pm 10\text{ V}$	25			15			V/mV
$V_{OP}$	Output Voltage Swing	$R_L = 10\text{ k}\Omega$	$\pm 12$	$\pm 14$		$\pm 12$	$\pm 14$		V
		$R_L = 2.0\text{ k}\Omega$	$\pm 10$	$\pm 13$		$\pm 10$	$\pm 13$		

# μA747

## μA747A and μA747E

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$ ,  $\pm 5.0 \text{ V} \leq V_{CC} \leq \pm 20 \text{ V}$ , unless otherwise specified.

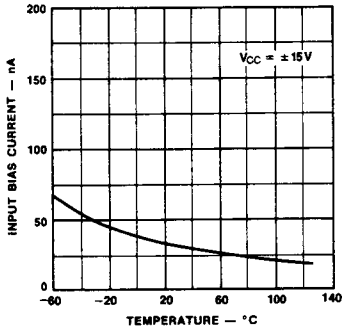
Symbol	Characteristic		Condition	Min	Typ	Max	Unit
$V_{IO}$	Input Offset Voltage		$R_S \leq 50 \Omega$		0.8	3.0	mV
$V_{IO \text{ adj}}$	Input Offset Voltage Adjustment Range		$V_{CC} = \pm 20 \text{ V}$	10			mV
$I_{IO}$	Input Offset Current				3.0	30	nA
$I_{IB}$	Input Bias Current				30	80	nA
$Z_I$	Input Impedance		$V_{CC} = \pm 20 \text{ V}$	1.0	6.0		MΩ
$P_c$	Power Consumption		$V_{CC} = \pm 20 \text{ V}$		160	300	mW
CMR	Common Mode Rejection		$V_{CC} = \pm 20 \text{ V}$ , $V_I = \pm 15 \text{ V}$ , $R_S = 50 \Omega$	80	95		dB
PSRR	Power Supply Rejection Ratio		$V_{CC} = +10 \text{ V}$ , $-20 \text{ V}$ to $V_{CC} = +20 \text{ V}$ , $-10 \text{ V}$ , $R_S = 50 \Omega$		15	50	μV/V
$I_{OS}$	Output Short Circuit Current		μA747A	10	25	40	mA
			μA747E	10	25	35	
$A_{VS}$	Large Signal Voltage Gain		$V_{CC} = \pm 20 \text{ V}$ , $R_L \geq 2.0 \text{ k}\Omega$ , $V_O = \pm 15 \text{ V}$	50			V/mV
TR	Transient Response	Rise time	$V_I = 50 \text{ mV}$ , $R_L = 2.0 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$ $A_V = 1.0$		0.25	0.8	μs
		Overshoot			6.0	20	%
BW	Bandwidth			0.437	1.5		MHz
SR	Slew Rate		$V_I = \pm 10 \text{ V}$ , $A_V = 1$	0.3	0.7		V/μs

The following specifications apply over the range of  $-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$  for μA747A,  $0^\circ\text{C} \leq T_A \leq +70^\circ\text{C}$  for μA747E.

$V_{IO}$	Input Offset Voltage					4.0	mV
$\Delta V_{IO}/\Delta T$	Input Offset Voltage Temperature Sensitivity					15	μV/°C
$I_{IO}$	Input Offset Current					70	nA
$I_{IB}$	Input Bias Current					210	nA
$\Delta I_{IO}/\Delta T$	Input Offset Current Temperature Sensitivity	μA747E	$T_A = 25^\circ\text{C}$ to $70^\circ\text{C}$			0.2	nA/°C
			$T_A = 0^\circ\text{C}$ to $25^\circ\text{C}$			0.5	
		μA747A	$T_A = 25^\circ\text{C}$ to $125^\circ\text{C}$			0.2	
			$T_A = -55^\circ\text{C}$ to $+25^\circ\text{C}$			0.5	
$Z_I$	Input Impedance		$V_{CC} = \pm 20 \text{ V}$	0.5			MΩ
$P_c$	Power Consumption	$V_{CC} = \pm 20 \text{ V}$	μA747A	$-55^\circ\text{C}$		330	mW
				$+125^\circ\text{C}$		270	
		μA747E			330		
$I_{OS}$	Output Short Circuit Current			10		40	mA
$A_{VS}$	Large Signal Voltage Gain		$V_{CC} = \pm 20 \text{ V}$ , $R_L \geq 2.0 \text{ k}\Omega$ , $V_O = \pm 15 \text{ V}$	32			V/mV
			$V_{CC} = \pm 5 \text{ V}$ , $R_L \geq 2.0 \text{ k}\Omega$ , $V_O = \pm 2.0 \text{ V}$	10			
$V_{OP}$	Output Voltage Swing		$V_{CC} = \pm 20 \text{ V}$	$R_L = 10 \text{ k}\Omega$	± 16		V
				$R_L = 2.0 \text{ k}\Omega$	± 15		
CS	Channel Separation		$V_{CC} = \pm 20 \text{ V}$	100			dB

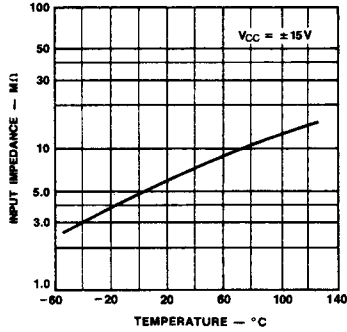
Typical Performance Curves for  $\mu A747A$  and  $\mu A747$

Input Bias Current vs Temperature



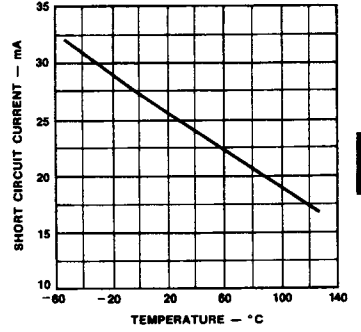
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Input Impedance vs Temperature



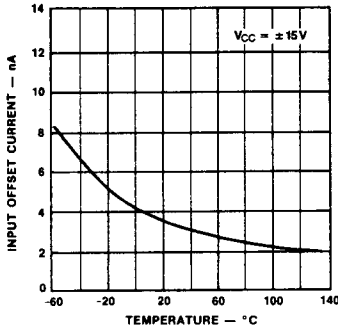
PC05521F

Short Circuit Current vs Temperature



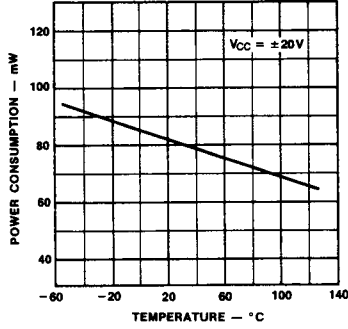
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Input Offset Current vs Temperature



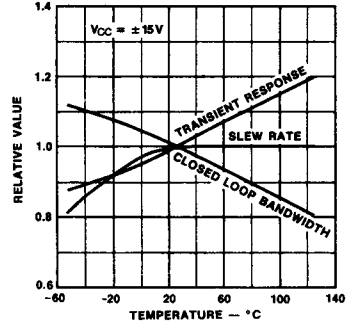
PC05540F

Power Consumption vs Temperature



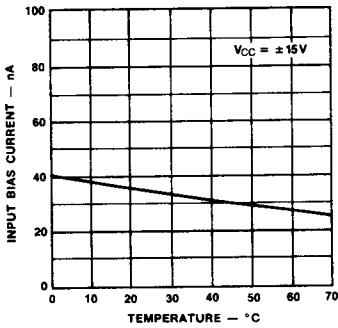
PC05550F

Frequency Characteristics vs Temperature



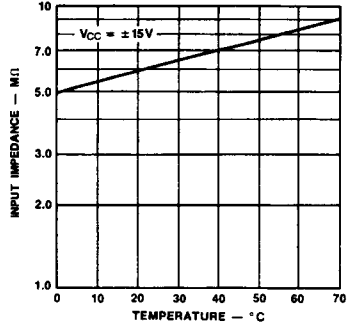
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Input Bias Current vs Temperature For  $\mu A747C/E$



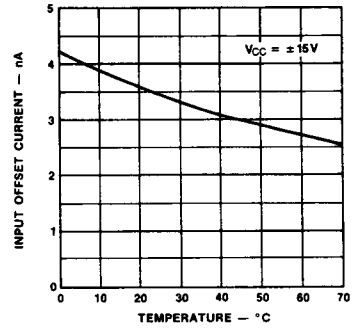
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Input Impedance vs Temperature For  $\mu A747C/E$



PC05581F

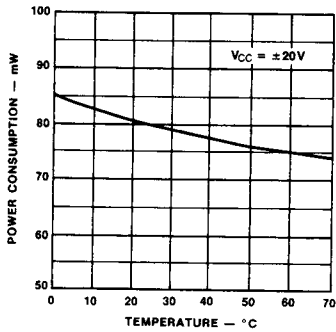
Input Offset Current vs Temperature For  $\mu A747C/E$



PC05590F

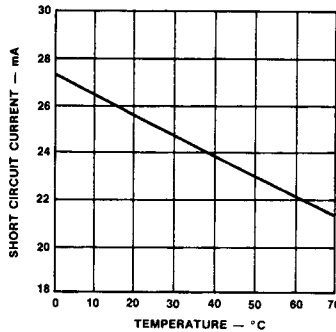
## Typical Performance Curves (Cont.)

**Power Consumption vs Temperature For μA747C/E**



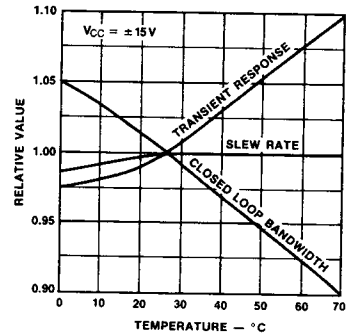
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**Short Circuit Current vs Temperature For μA747C/E**



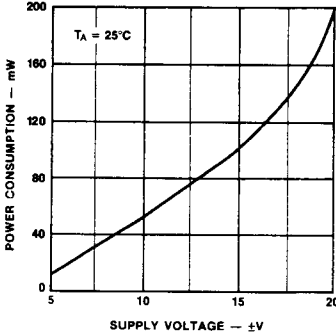
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**Frequency Characteristics vs Temperature For μA747C/E**



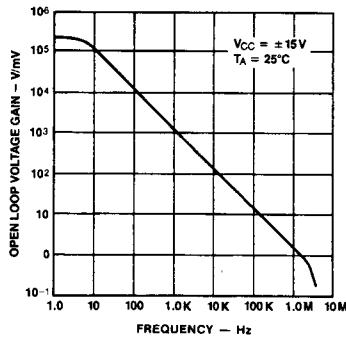
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**Power Consumption vs Supply Voltage**



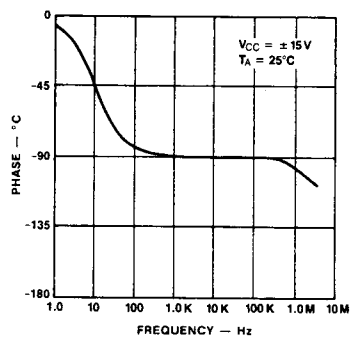
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**Open Loop Frequency Response**



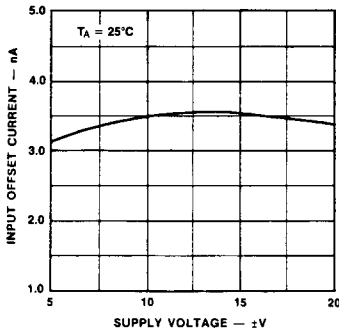
PC05641F

**Open Loop Phase Response vs Frequency**



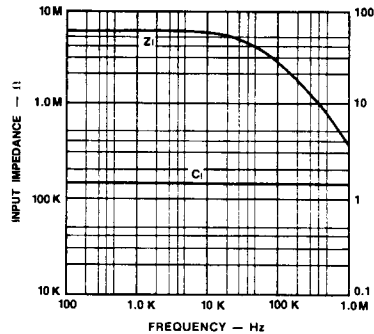
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**Input Offset Current vs Supply Voltage**



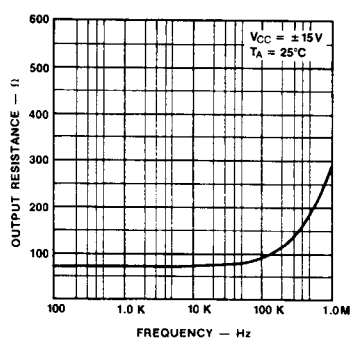
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**Input Impedance and Input Capacitance vs Frequency**



PC05671F

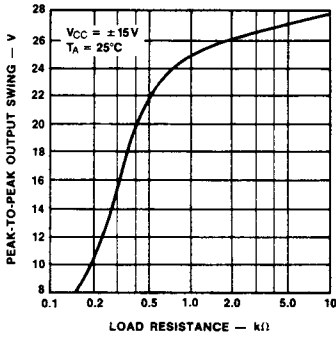
**Output Resistance vs Frequency**



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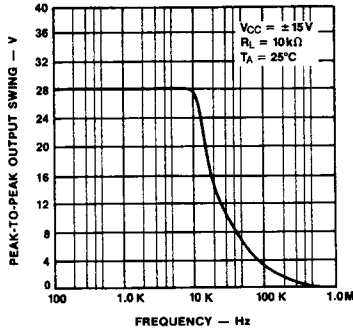
## Typical Performance Curves (Cont.)

### Output Voltage Swing vs Load Resistance



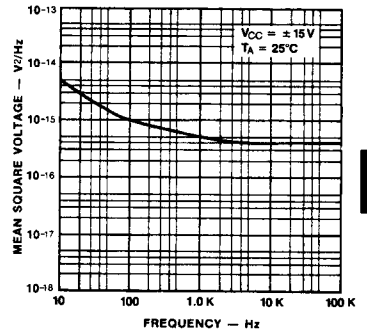
PC05690F

### Output Voltage Swing vs Frequency



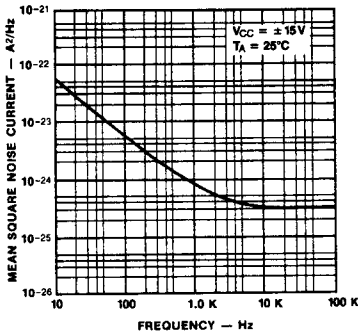
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### Input Noise Voltage Density vs Frequency



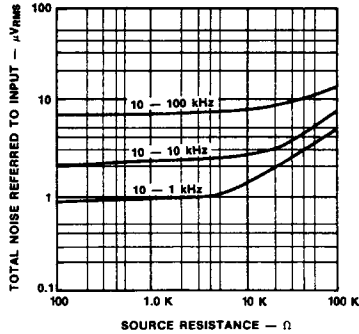
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### Input Noise Current Density vs Frequency



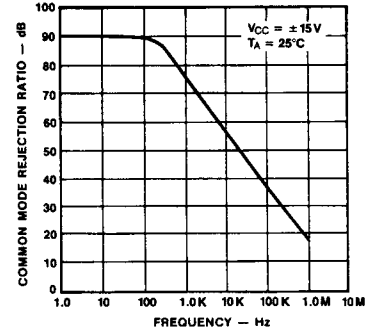
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### Broadband Noise for Various Bandwidths



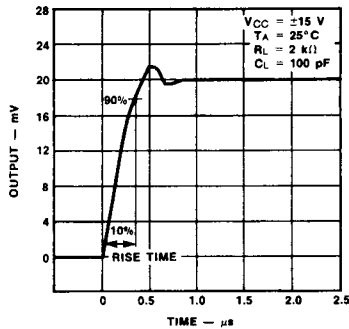
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### Common Mode Rejection Ratio vs Frequency μA747/C



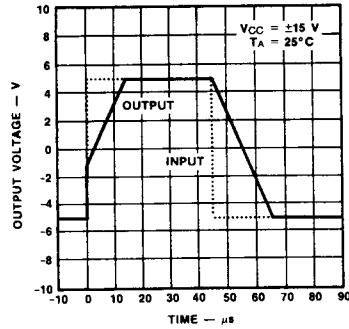
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### Transient Response For μA747/C



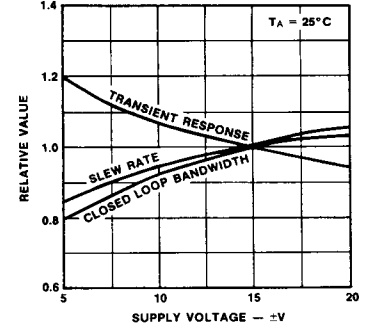
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### Voltage Follower Large Signal Pulse Response For μA747/C



PC05760F

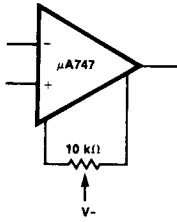
### Frequency Characteristics vs Supply Voltage For μA747/C



PC05770F

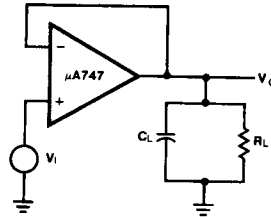
Test Circuits

Voltage Offset Null Circuit



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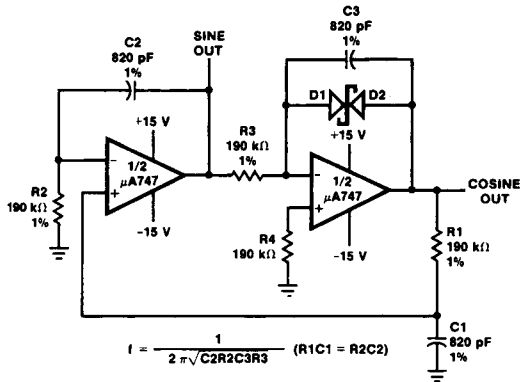
Transient Response Test Circuit



CR01431F

Typical Applications

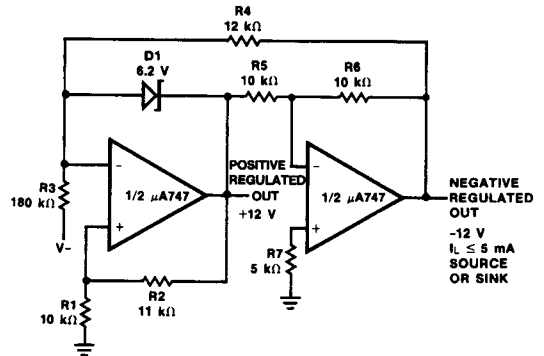
Quadrature Oscillator



$$f = \frac{1}{2\pi\sqrt{C2R2C3R3}} \quad (R1C1 = R2C2)$$

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Tracking Positive and Negative Voltage References



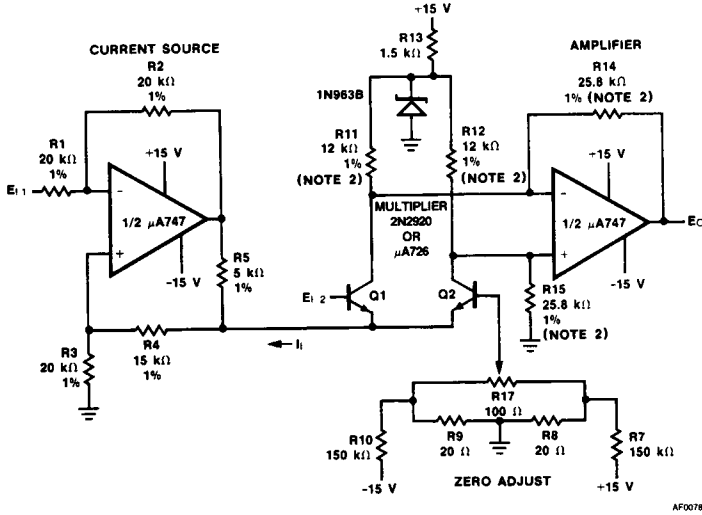
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$$\text{Positive Output} = V_{D1} \times \frac{R1 + R2}{R2}$$

$$\text{Negative Output} = -\text{Positive Output} \times \frac{R6}{R5}$$

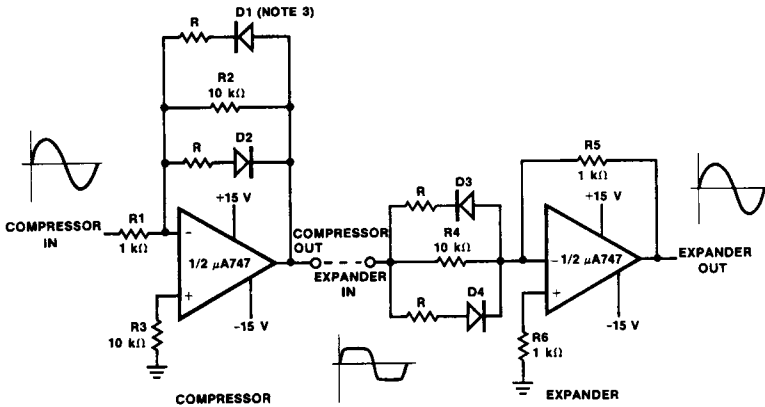


Analog Multiplier



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Compressor/Expander Amplifiers (Note 1)



Notes

1. Maximum Compression Expansion Ratio =  $R/R$  ( $10 \text{ k}\Omega > R \geq 0$ )
2. Matched to 0.1%  $E_O = 100 E_{i1} \times E_{i2}$
3. Diodes D1 through D4 are matched FD666 or Equivalent